

## HIGH POWER DPDT SWITCH GaAs MMIC

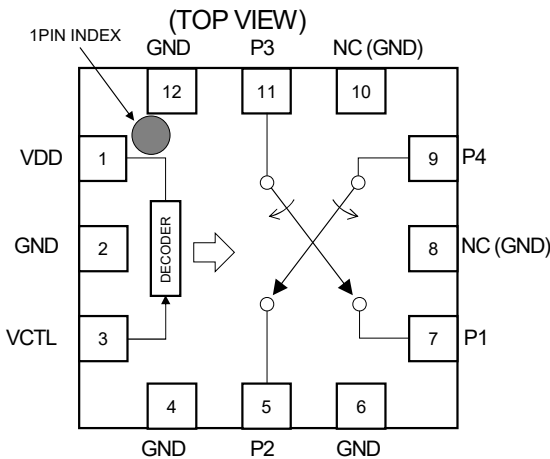
### FEATURES

- AEC-Q100 grade 2 qualified
- Low voltage operation  $V_{DD} = 2.7\text{ V typ.}$
- Logic control voltage  $V_{CTL(H)} = 1.35\text{ to }5.0\text{ V}$
- Low insertion loss
  - 0.25 dB typ. @  $f = 900\text{ MHz}$ ,  $P_{IN} = +35\text{ dBm}$
  - 0.35 dB typ. @  $f = 1900\text{ MHz}$ ,  $P_{IN} = +33\text{ dBm}$
  - 0.45 dB typ. @  $f = 2700\text{ MHz}$ ,  $P_{IN} = +27\text{ dBm}$
- Low harmonics
  - $2f_0 = -89\text{ dBm typ.}$  @  $f = 786.5\text{ MHz}$ ,  $P_{IN} = +23\text{ dBm}$
  - $3f_0 = -89\text{ dBm typ.}$  @  $f = 710\text{ MHz}$ ,  $P_{IN} = +23\text{ dBm}$
- High power handling
  - $P_{-0.1dB} = +36\text{ dBm min.}$
- Package with wettable flank EQFN12-ET
  - ( $2.0 \times 2.0 \times 0.78\text{ mm typ.}$ , pin pitch  $0.5\text{ mm}$ )
- RoHS compliant and Halogen Free, MSL1

### APPLICATION

- eCall
- Telematics
- Antenna swapping, general purpose switching applications
- LTE, UMTS, CDMA, GSM systems

### BLOCK DIAGRAM (EQFN12-ET)



### GENERAL DESCRIPTION

The NJG1812AMET-A is a GaAs DPDT switch MMIC suitable for antenna swapping of LTE/UMTS/CDMA/GSM applications.

This switch features very low insertion loss, low distortion and excellent linearity performance with 1.8 V 1bit control voltage at high frequency up to 3 GHz.

Integrated ESD protection device on each port achieves excellent ESD robustness. No DC blocking capacitors are required for all RF ports unless DC is biased externally.

EQFN12-ET package with wettable flank structure corresponds to Automated Optical Inspection (AOI).

### TRUTH TABLE

“H” =  $V_{CTL(H)}$ , “L” =  $V_{CTL(L)}$

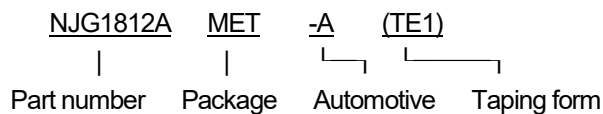
$V_{CTL}$	Path
L	P1-P4
	P2-P3
H	P1-P3
	P2-P4

### PIN CONFIGURATION

PIN NO.	SYMBOL	DESCRIPTION
1	VDD	Voltage supply terminal
2	GND	Ground terminal
3	VCTL	Control signal input terminal.
4	GND	Ground terminal
5	P2	RF input/output
6	GND	Ground terminal
7	P1	RF input/output
8	NC (GND)	No connected terminal (Connect to ground)
9	P4	RF input/output
10	NC (GND)	No connected terminal (Connect to ground)
11	P3	RF input/output
12	GND	Ground terminal
Exposed pad	GND	Ground terminal

# Automotive NJG1812AMET-A

## ■ PRODUCT NAME INFORMATION



## ■ ORDERING INFORMATION

PART NUMBER	PACKAGE OUTLINE	RoHS	HALOGEN-FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ (pcs.)
NJG1812AMET-A	EQFN12-ET	Yes	Yes	SnBi	1812 A A	8.5	3,000

## ■ ABSOLUTE MAXIMUM RATINGS

(General conditions:  $T_a = 25^\circ\text{C}$ ,  $Z_s = Z_l = 50 \Omega$ )

PARAMETER	SYMBOL	RATINGS	UNIT
RF Input Power	$P_{IN}$	+38 <sup>(1)</sup>	dBm
Supply Voltage	$V_{DD}$	5.0	V
Control Voltage	$V_{CTL}$	5.0	V
Power Dissipation <sup>(2)</sup>	$P_D$	1400	mW
Operating Temperature	$T_{opr}$	-40 to +105	°C
Storage Temperature	$T_{stg}$	-55 to +150	°C

(1):  $V_{DD} = 2.7 \text{ V}$ , ON port

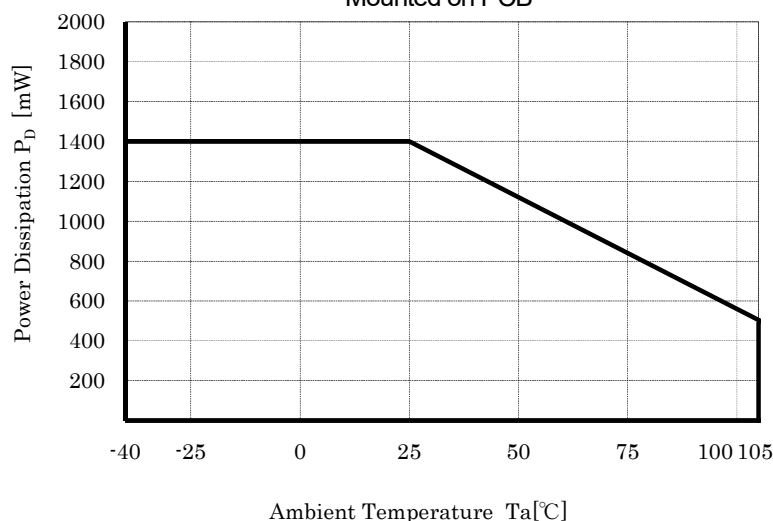
(2): Four-layer FR4 PCB with through-hole (101.5 x 114.5 mm),  $T_j = 150^\circ\text{C}$

## ■ POWER DISSIPATION VS. AMBIENT TEMPERATURE

Please, refer to the following Power Dissipation and Ambient Temperature.

(Please note the surface mount package has a small maximum rating of Power Dissipation [ $P_D$ ], a special attention should be paid in designing of thermal radiation.)

**Power Dissipation—Ambient Temperature Characteristic**  
Mounted on PCB



# Automotive NJG1812AMET-A

## ■ ELECTRICAL CHARACTERISTICS 1 (DC CHARACTERISTICS)

(General conditions:  $T_a = 25^\circ\text{C}$ ,  $Z_s = Z_l = 50\ \Omega$ , with application circuit)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage	$V_{DD}$		2.4	2.7	5.0	V
Operating Current	$I_{DD}$	No RF input	-	90	180	$\mu\text{A}$
Control Voltage (LOW)	$V_{CTL(L)}$		0	-	0.45	V
Control Voltage (HIGH)	$V_{CTL(H)}$		1.35	1.8	5.0	V
Control Current	$I_{CTL}$	$V_{CTL(H)} = 1.8\text{V}$	-	4	10	$\mu\text{A}$

## ■ ELECTRICAL CHARACTERISTICS 2 (RF CHARACTERISTICS)

(General conditions:  $T_a = +25^\circ\text{C}$ ,  $Z_s = Z_l = 50\ \Omega$ ,  $V_{DD} = 2.7\text{V}$ ,  $V_{CTL(H)} = 1.8\text{V}$ ,  $V_{CTL(L)} = 0\text{V}$ , with application circuit)

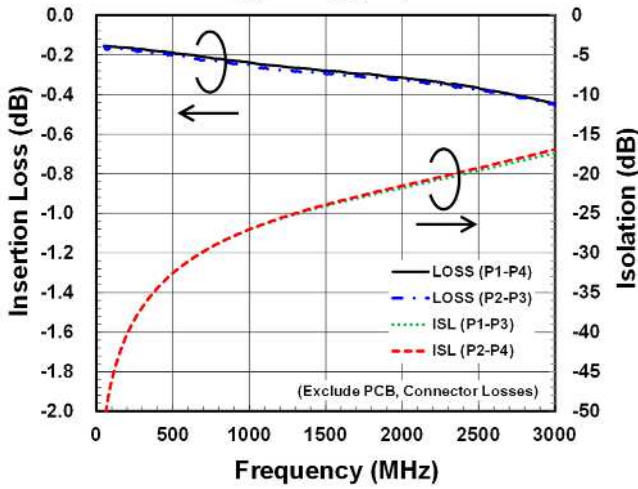
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Insertion Loss	LOSS	$f = 900\text{ MHz}$ , $P_{IN} = +35\text{ dBm}$	-	0.25	0.45	dB
		$f = 1900\text{ MHz}$ , $P_{IN} = +33\text{ dBm}$	-	0.35	0.55	
		$f = 2700\text{ MHz}$ , $P_{IN} = +27\text{ dBm}$	-	0.45	0.65	
Isolation	ISL	$f = 900\text{ MHz}$ , $P_{IN} = +35\text{ dBm}$	23	25	-	dB
		$f = 1900\text{ MHz}$ , $P_{IN} = +33\text{ dBm}$	18	20	-	
		$f = 2700\text{ MHz}$ , $P_{IN} = +27\text{ dBm}$	15	17	-	
Input Power at 0.1dB Compression Point	$P_{-0.1dB}$	$f = 2700\text{ MHz}$	+36	-	-	dBm
2nd Harmonics	2fo	$f = 900\text{ MHz}$ , $P_{IN} = +33\text{ dBm}$	-	-	-40	dBm
		$f = 1900\text{ MHz}$ , $P_{IN} = +30\text{ dBm}$	-	-	-40	
		$f = 2700\text{ MHz}$ , $P_{IN} = +23\text{ dBm}$	-	-	-60	
		$f = 786.5\text{ MHz}$ , $P_{IN} = +23\text{ dBm}$	-	-89	-81	
3rd Harmonics	3fo	$f = 900\text{ MHz}$ , $P_{IN} = +33\text{ dBm}$	-	-	-40	dBm
		$f = 1900\text{ MHz}$ , $P_{IN} = +30\text{ dBm}$	-	-	-40	
		$f = 2700\text{ MHz}$ , $P_{IN} = +23\text{ dBm}$	-	-	-60	
		$f = 710\text{ MHz}$ , $P_{IN} = +23\text{ dBm}$	-	-89	-81	
		$f = 786.5\text{ MHz}$ , $P_{IN} = +23\text{ dBm}$	-	-89	-81	
2nd order intermodulation	IMD2	$f_{TX} = 835\text{ MHz}$ , $P_{TX} = +20\text{ dBm}$ , $f_{jam} = 1715\text{ MHz}$ , $P_{jam} = -15\text{ dBm}$ , $f_{meas} = 880\text{ MHz}$	-	-110	-105	dBm
3rd order intermodulation	IMD3	$f_{TX} = 835\text{ MHz}$ , $P_{TX} = +20\text{ dBm}$ , $f_{jam} = 790\text{ MHz}$ , $P_{jam} = -15\text{ dBm}$ , $f_{meas} = 880\text{ MHz}$	-	-110	-105	dBm
Triple Beat Ratio	TBR	$f_{TX1} = 835.5\text{ MHz}$ , $P_{TX1} = +21.5\text{ dBm}$ , $f_{TX2} = 836.5\text{ MHz}$ , $P_{TX2} = +21.5\text{ dBm}$ , $f_{jam} = 881.5\text{ MHz}$ , $P_{jam} = -30\text{ dBm}$ , $f_{meas} = 881.5 \pm 1\text{ MHz}$	-	93	-	dBc
VSWR	VSWR	P1 to P4 Terminal, $f = 2700\text{ MHz}$	-	1.1	1.5	-
Switching time	$T_{SW}$	50% $V_{CTL}$ to 10/90% RF	-	1	5	$\mu\text{s}$

# Automotive NJG1812AMET-A

## ■ ELECTRICAL CHARACTERISTICS (With application circuit, loss of external circuit are excluded.)

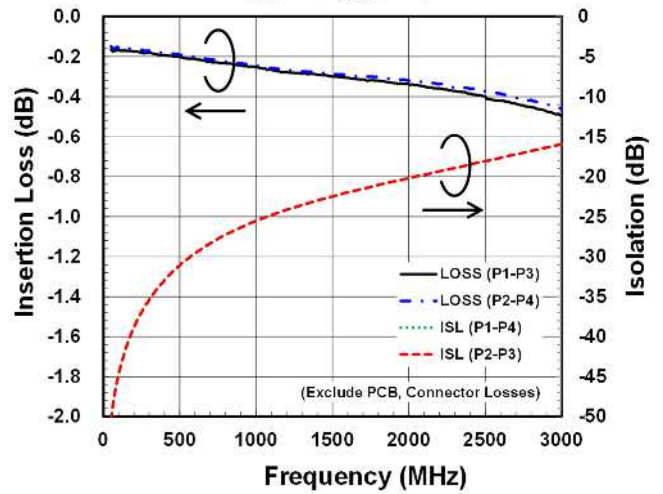
### LOSS, ISL vs. Frequency

( $V_{DD}=2.7V$ ,  $V_{CTL(L)}=0V$ )



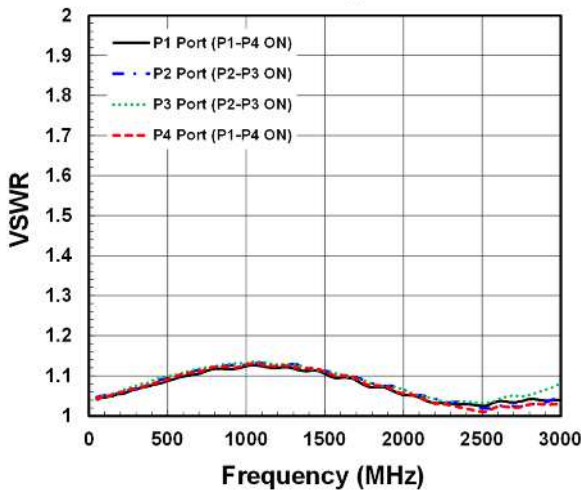
### LOSS, ISL vs. Frequency

( $V_{DD}=2.7V$ ,  $V_{CTL(H)}=1.8V$ )



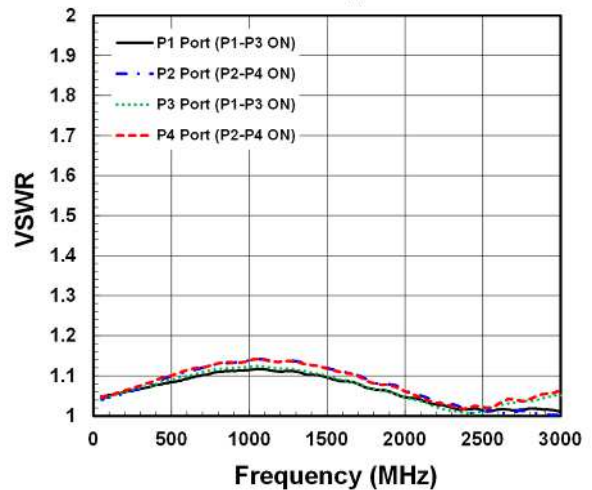
### VSWR vs. Frequency

( $V_{DD}=2.7V$ ,  $V_{CTL(L)}=0V$ )



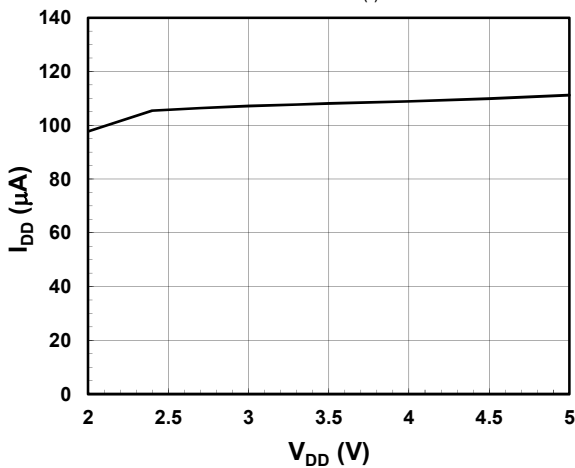
### VSWR vs. Frequency

( $V_{DD}=2.7V$ ,  $V_{CTL(H)}=1.8V$ )



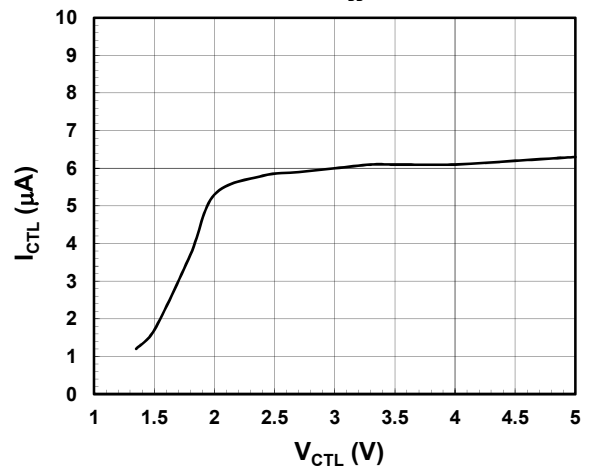
### $I_{DD}$ vs. $V_{DD}$

(No RF Input,  $V_{CTL(L)}=0V$ )



### $I_{CTL}$ vs. $V_{CTL}$

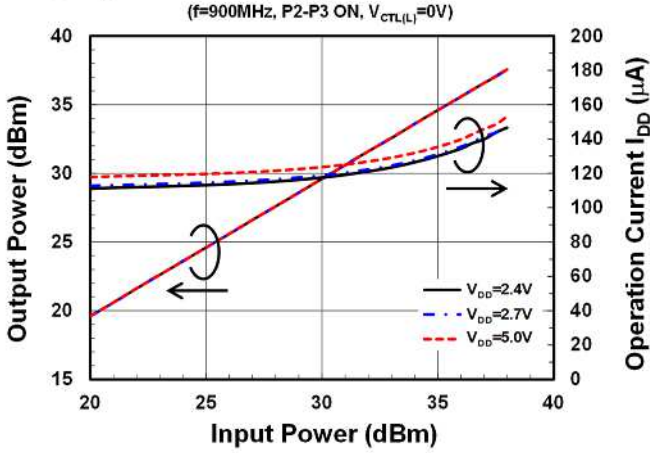
(No RF Input,  $V_{DD}=2.7V$ )



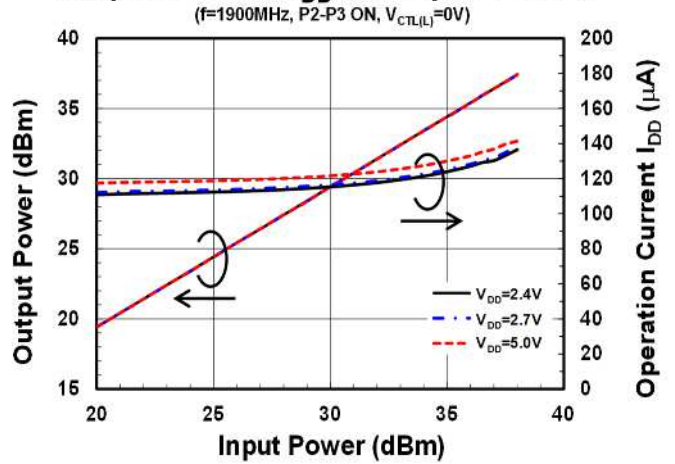
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## ■ ELECTRICAL CHARACTERISTICS (With application circuit, loss of external circuit are excluded.)

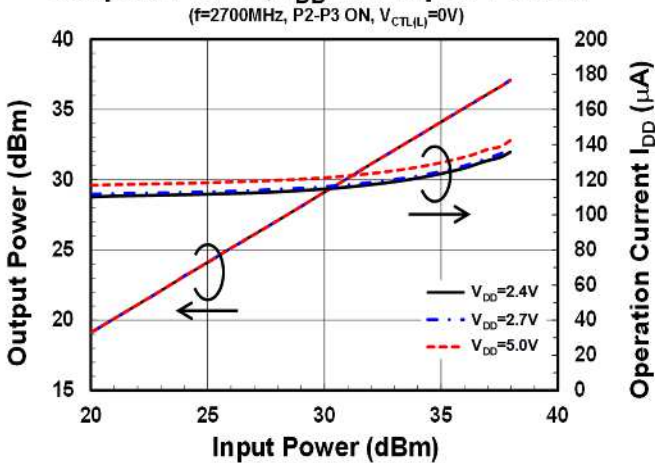
**Output Power,  $I_{DD}$  vs. Input Power**



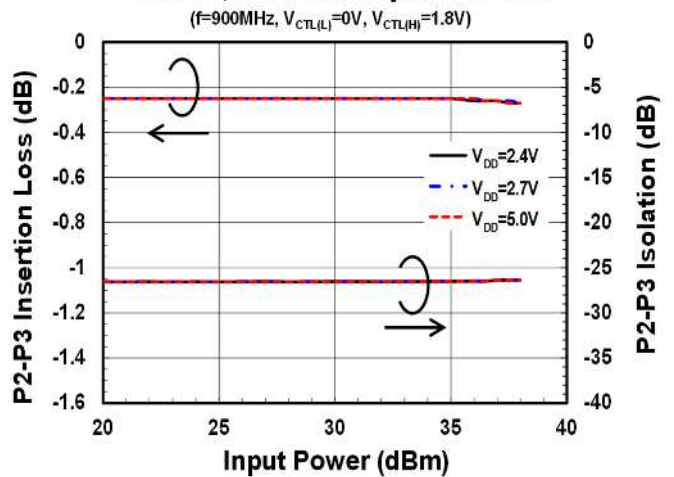
**Output Power,  $I_{DD}$  vs. Input Power**



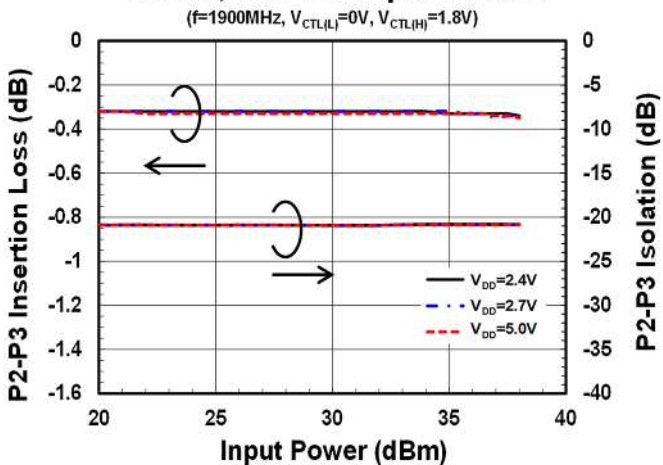
**Output Power,  $I_{DD}$  vs. Input Power**



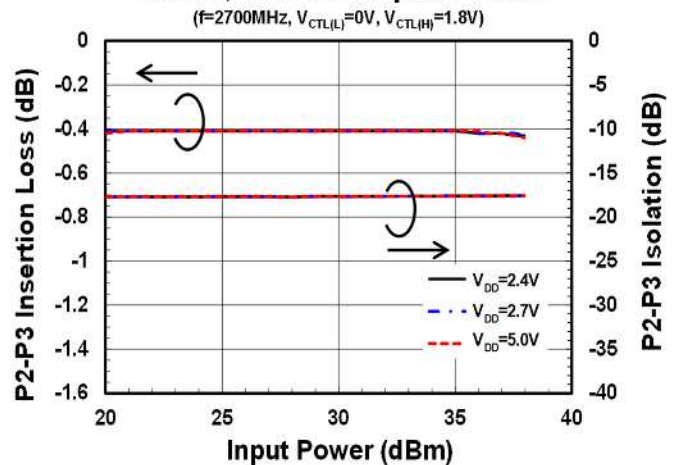
**LOSS, ISL vs. Input Power**



**LOSS, ISL vs. Input Power**

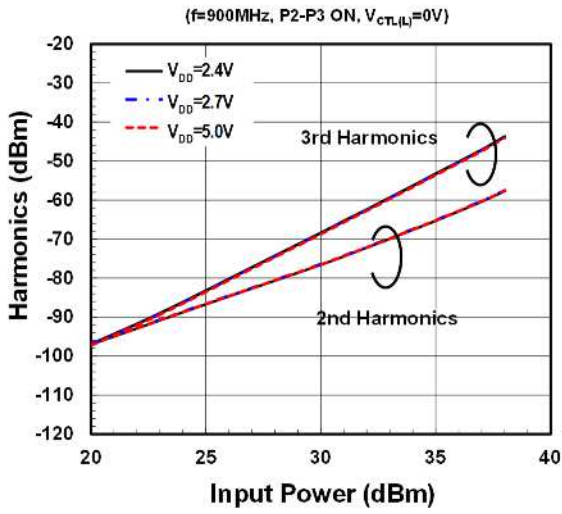


**LOSS, ISL vs. Input Power**

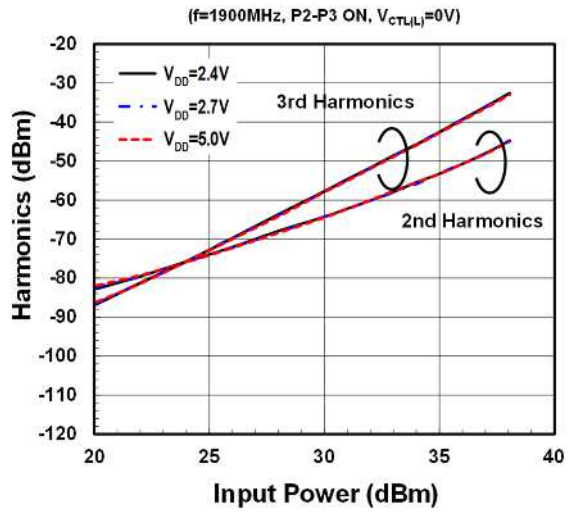


■ ELECTRICAL CHARACTERISTICS (With application circuit, loss of external circuit are excluded.)

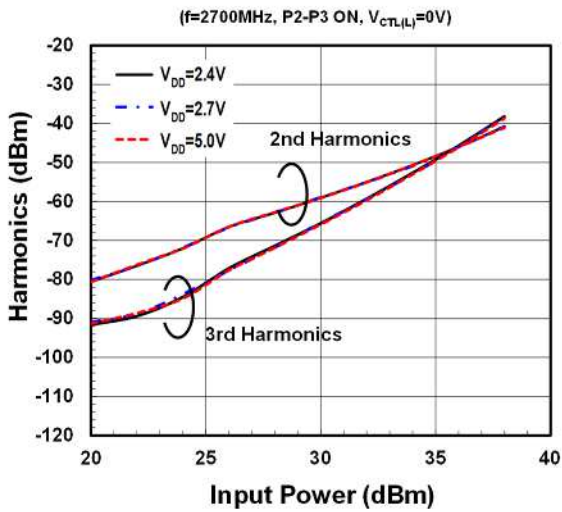
**Harmonics vs. Input Power**



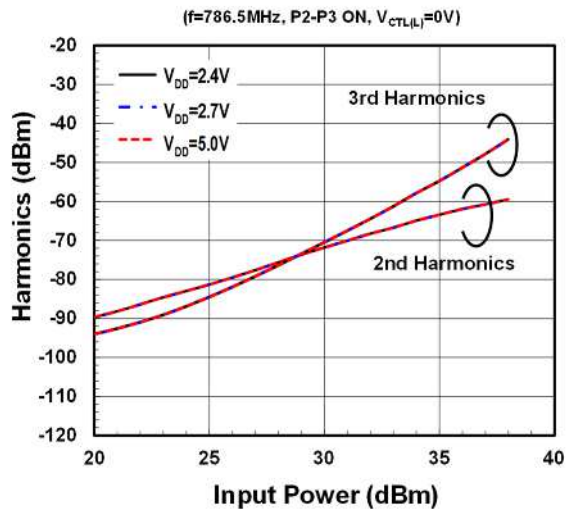
**Harmonics vs. Input Power**



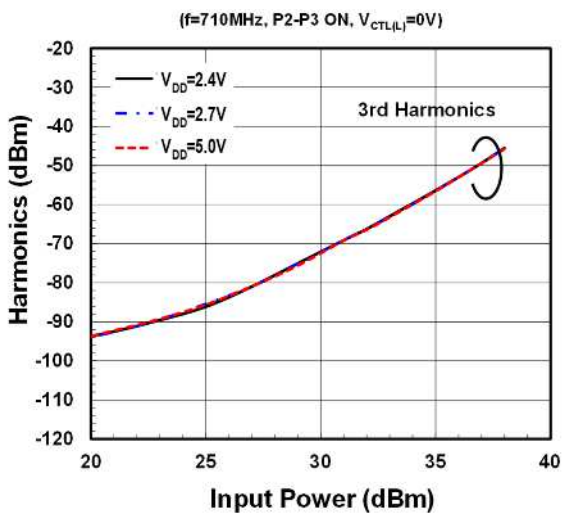
**Harmonics vs. Input Power**



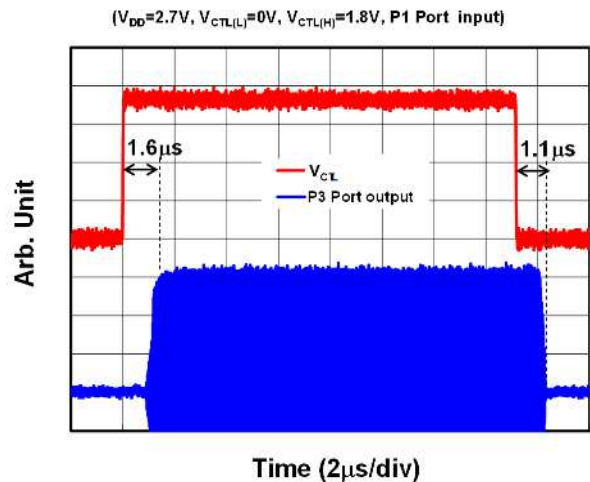
**Harmonics vs. Input Power**



**Harmonics vs. Input Power**



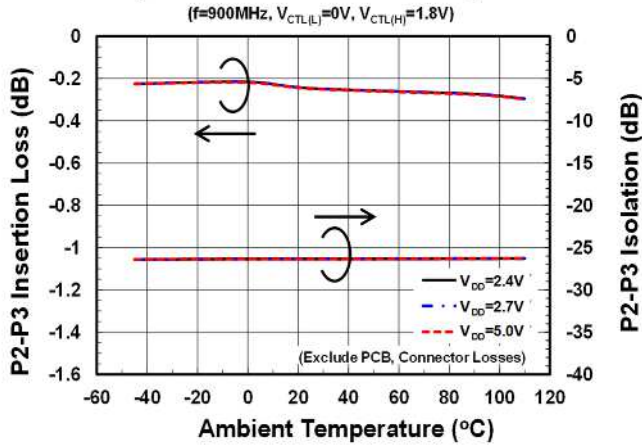
**Switching time**



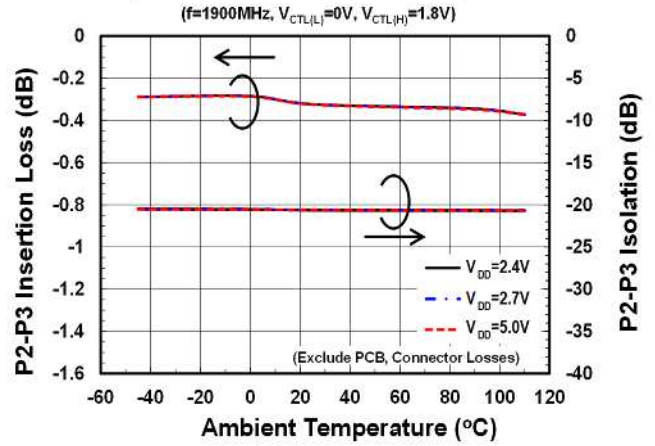
# Automotive NJG1812AMET-A

## ■ ELECTRICAL CHARACTERISTICS (With application circuit, loss of external circuit are excluded.)

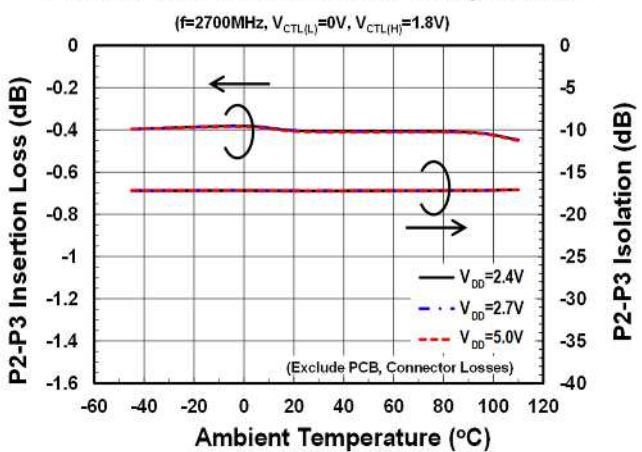
### LOSS, ISL vs. Ambient Temperature



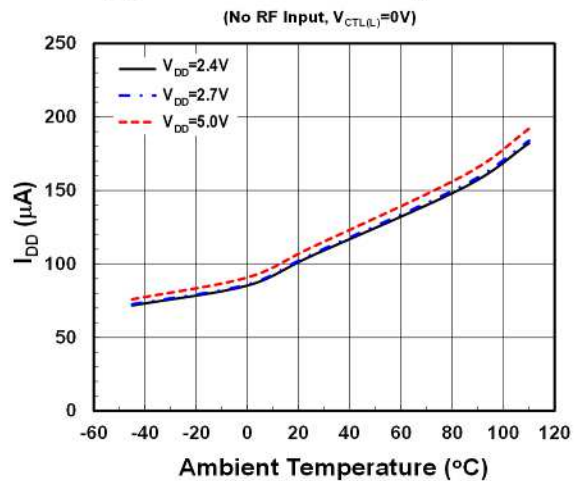
### LOSS, ISL vs. Ambient Temperature



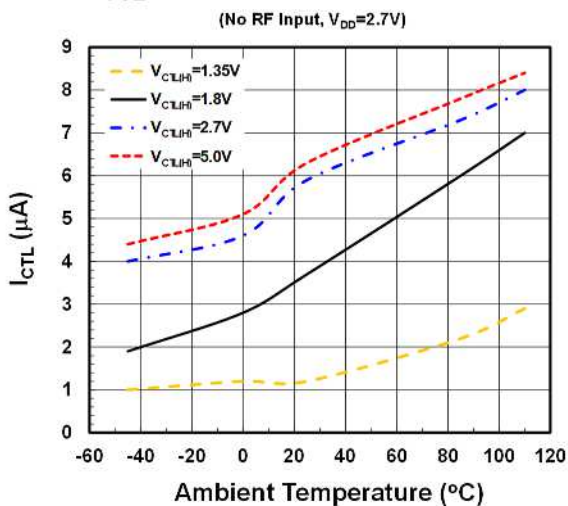
### LOSS, ISL vs. Ambient Temperature



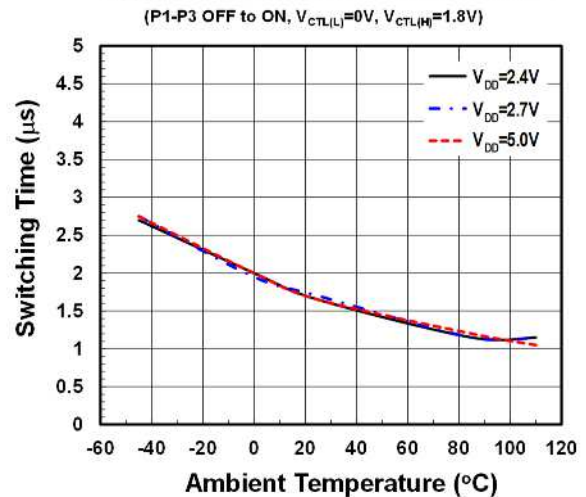
### $I_{DD}$ vs. Ambient Temperature



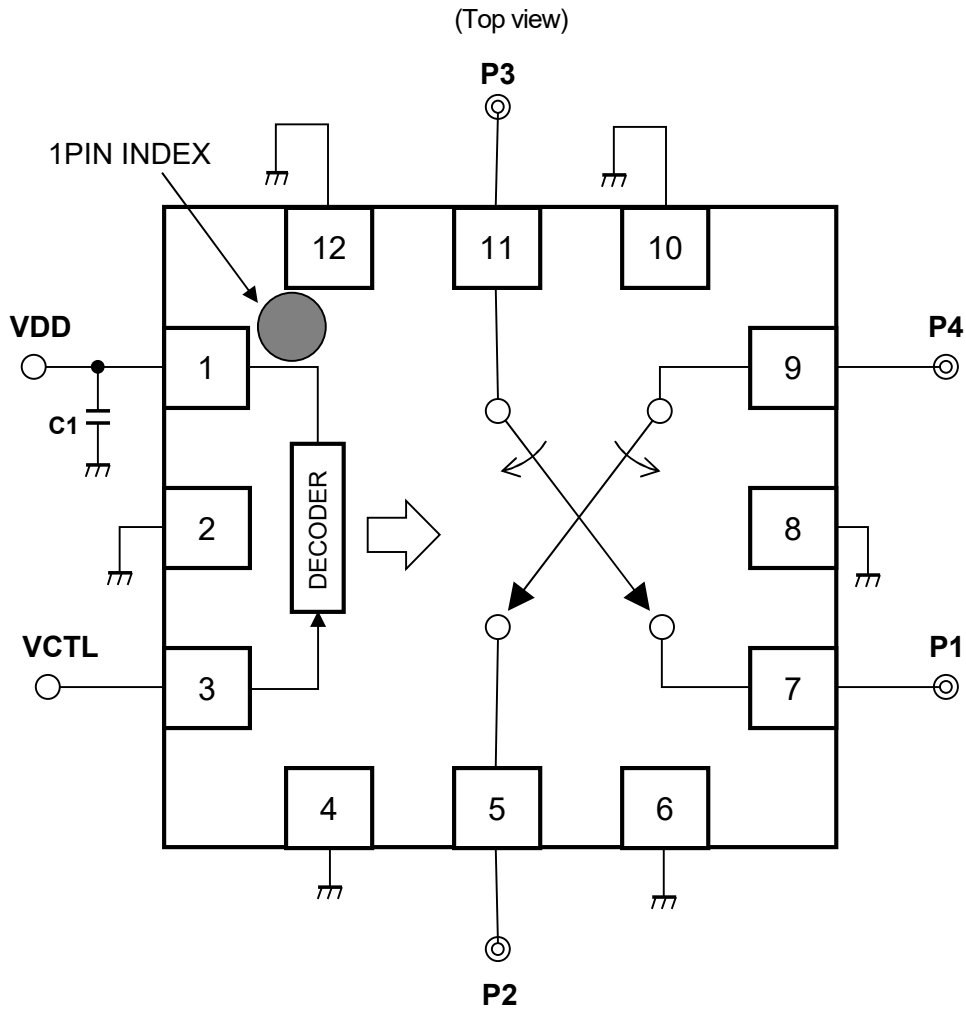
### $I_{CTL}$ vs. Ambient Temperature



### $T_{SW}$ vs. Ambient Temperature



## ■ APPLICATION CIRCUIT



Note:

No DC blocking capacitors are required on all RF ports, unless DC is biased externally.

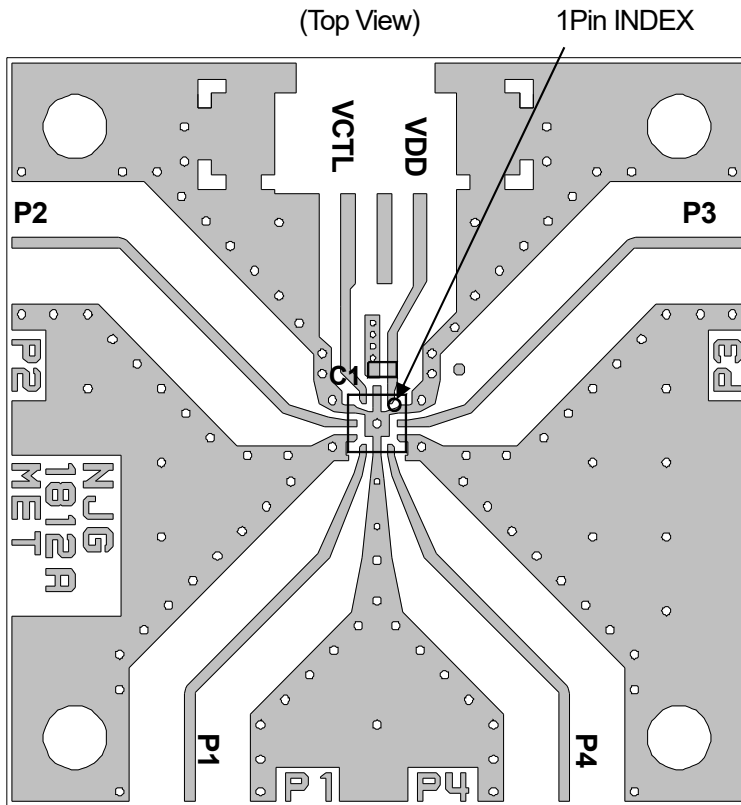
## ■ PARTS LIST

Part ID	Value	Notes
C1	1000 pF	MURATA (GRM15)



# Automotive NJG1812AMET-A

## ■ EVALUATION BOARD



PCB (FR-4):

$t = 0.2 \text{ mm}$

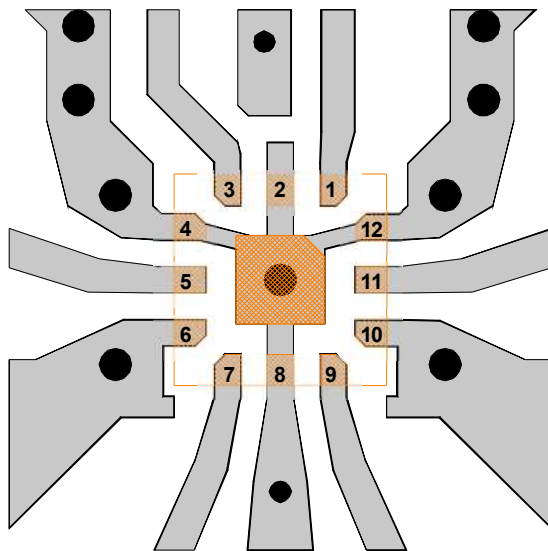
MICROSTRIP LINE WIDTH = 0.37 mm ( $Z_0 = 50 \Omega$ )

PCB SIZE = 26 mm x 26 mm

Losses of PCB and connectors,  $T_a = +25^\circ\text{C}$

Frequency [GHz]	Loss [dB]
0.9	0.23
1.9	0.43
2.7	0.55

## ■ PCB LAYOUT GUIDELINE (EQFN12-ET)



■ PCB

■ PKG terminal

□ PKG outline

● Ground via hole  
 Diameter  $\Phi = 0.3 \text{ mm}$

● Ground via hole  
 Diameter  $\Phi = 0.2 \text{ mm}$

## PRECAUTIONS

- [1] For avoiding the degradation of RF performance, the bypass capacitor (C1) should be placed as close as possible to VDD terminal
- [2] For good RF performance, all GND terminals are must be connected to PCB ground plane of substrate, and through - holes for GND should be placed near the IC.
- [3] Please connect Exposed PAD to PCB ground plane of substrate, and through - holes for ground should be placed under the IC.

# Automotive NJG1812AMET-A

## ■ HANDLING PRECAUTIONS

PIN NO.	SYMBOL	ESD RATINGS				Charged Device Model <sup>(4)</sup>
		Human Body Model <sup>(3)</sup>				
Common terminal		Ground	VDD	I/O		
1	VDD	Class 2	COM.	-	Class C6	
2	GND	COM.	Class 2	-	Class C6	
3	VCTL	Class 2	Class 1C	Class 1C	Class C6	
4	GND	COM.	Class 1C	-	Class C6	
5	P2	Class 2	Class 1A	Class 2	Class C6	
6	GND	COM.	Class 1A	-	Class C6	
7	P1	Class 2	Class 1B	Class 2	Class C6	
8	NC(GND)	COM.	Class 2	-	Class C6	
9	P4	Class 2	Class 1C	Class 2	Class C6	
10	NC(GND)	COM.	Class 1C	-	Class C6	
11	P3	Class 2	Class 1B	Class 2	Class C6	
12	GND	COM.	Class 1C	-	Class C6	

(3): According to JEDEC JS-001

(4): According to JEDEC JS-002

CAUTION: This product may be damaged with electric static discharge (ESD) or spike voltage. Please handle with care to avoid these damages.


## ■ RECOMMENDED FOOTPRINT PATTERN (EQFN12-ET PACKAGE) <Reference>

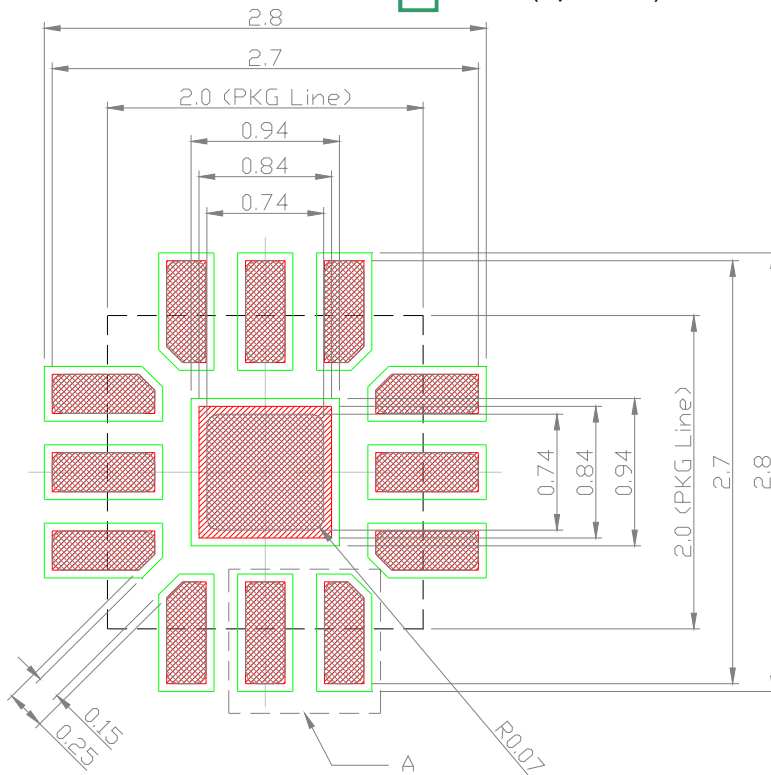
Package: 2.0 mm x 2.0 mm

Pin pitch: 0.5 mm

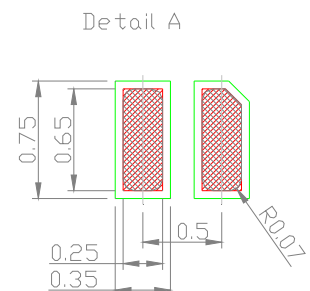
 : Land

 : Mask (Open area) \*Metal mask thickness : 120 μm

 : Resist(Open area)

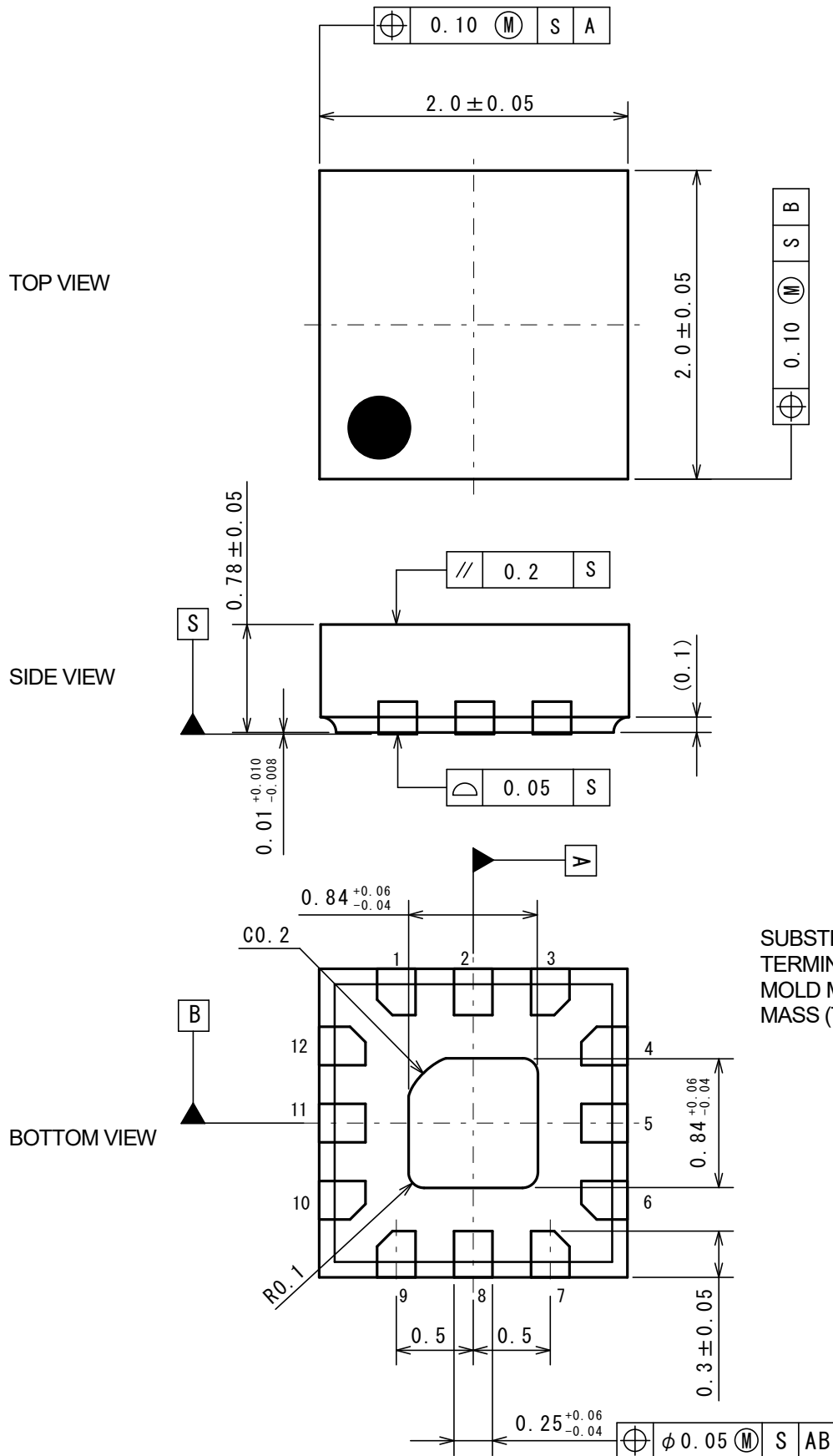


Units: mm



# Automotive NJG1812AMET-A

## PACKAGE OUTLINE (EQFN12-ET)



SUBSTRATE MATERIAL: Copper  
 TERMINAL FINISH: Sn-Bi plating  
 MOLD MATERIAL: Epoxy resin  
 MASS (TYP.): 8.5 mg

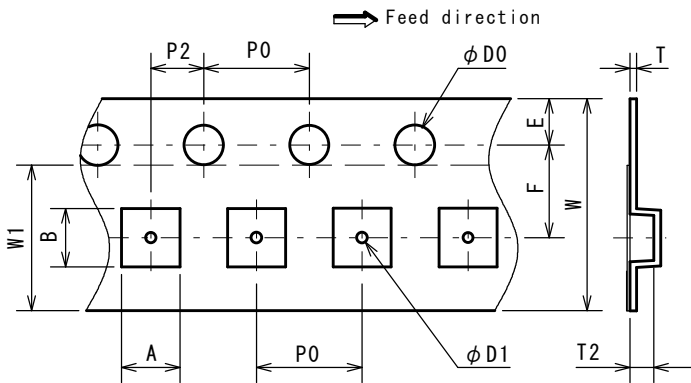
Unit: mm

# Automotive NJG1812AMET-A

## PACKING SPECIFICATION (EQFN12-ET)

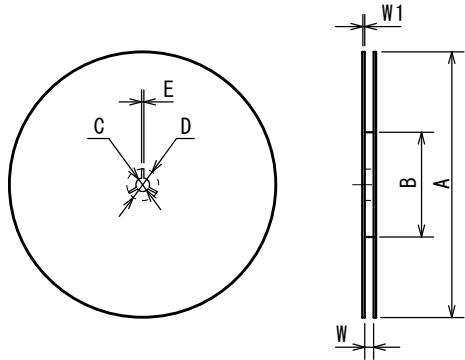
### TAPING DIMENSIONS

UNIT: mm



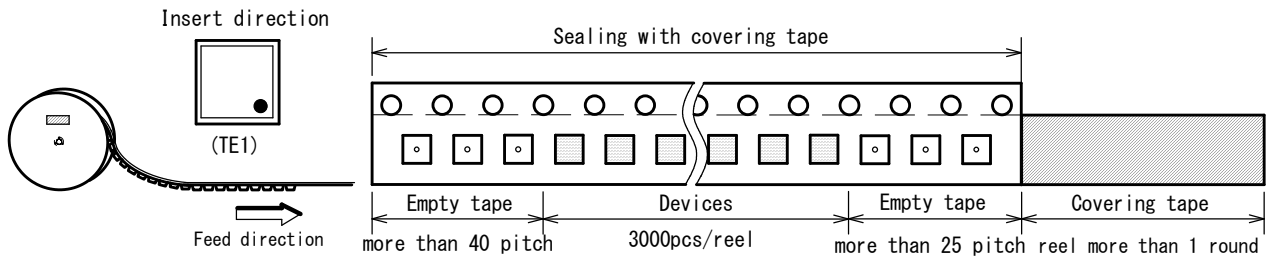
SYMBOL	DIMENSION	REMARKS
A	2.26±0.05	BOTTOM DIMENSION
B	2.26±0.05	BOTTOM DIMENSION
D0	1.5 <sup>+0.1</sup> <sub>0</sub>	
D1	0.5 <sup>+0.1</sup> <sub>0</sub>	
E	1.75±0.1	
F	3.5±0.05	
P0	4.0±0.1	
P1	4.0±0.1	
P2	2.0±0.05	
T	0.25±0.05	
T2	0.95±0.05	
W	8.0 <sup>+0.3</sup> <sub>-0.1</sub>	
W1	5.5	THICKNESS 0.1max

### REEL DIMENSIONS

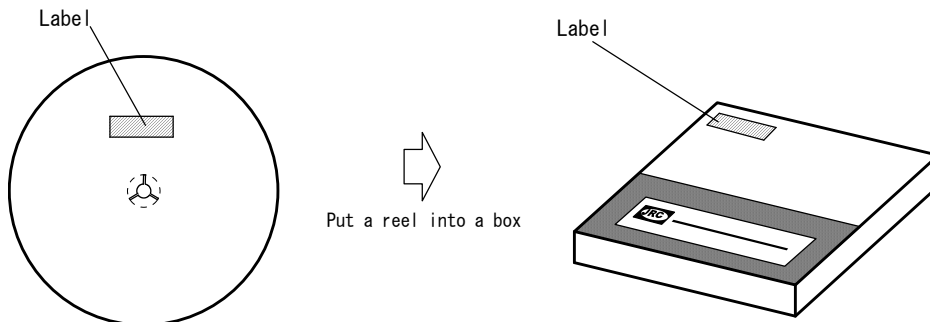


SYMBOL	DIMENSION
A	φ 180 <sup>0</sup> <sub>-1.5</sub>
B	φ 60 <sup>+1</sup> <sub>0</sub>
C	φ 13±0.2
D	φ 21±0.8
E	2±0.5
W	9 <sup>+1</sup> <sub>0</sub>
W1	1.2

### TAPING STATE



### PACKING STATE



# Automotive NJG1812AMET-A

## ■ REVISION HISTORY

Date	Revision	Changes
15.Oct.2021	Ver.1.1	Revised FEATURES Revised TRUTH TABLE Revised ELECTRICAL CHARACTERISTICS (No change for spec values) Revised EVALUATION BOARD (added 1 pin index mark) Revised PCB LAYOUT GUIDELINE Revised CAUTION
20.Aug.2020	Ver.1.0	New Release

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3. This product and any technical information relating thereto are subject to complementary export controls (so-called KNOW controls) under the Foreign Exchange and Foreign Trade Law, and related politics ministerial ordinance of the law. (Note that the complementary export controls are inapplicable to any application-specific products, except rockets and pilotless aircraft, that are insusceptible to design or program changes.) Accordingly, when exporting or carrying abroad this product, follow the Foreign Exchange and Foreign Trade Control Law and its related regulations with respect to the complementary export controls.
4. The technical information described in this document shows typical characteristics and example application circuits for the products. The release of such information is not to be construed as a warranty of or a grant of license under our or any third party's intellectual property rights or any other rights.
5. The products listed in this document are intended and designed for automotive applications. Those customers intending to use a product in an application requiring extreme quality and reliability, for example, in a highly specific application where the failure or misoperation of the product could result in human injury or death should first contact us.
  - Aerospace Equipment
  - Equipment Used in the Deep Sea
  - Power Generator Control Equipment (nuclear, steam, hydraulic, etc.)
  - Life Maintenance Medical Equipment
  - Fire Alarms / Intruder Detectors
  - Vehicle Control Equipment (airplane, railroad, ship, etc.)
  - Various Safety Devices
  - Traffic control system
  - Combustion equipment

In case your company desires to use this product for any applications other than general electronic equipment mentioned above, make sure to contact our company in advance. Note that the important requirements mentioned in this section are not applicable to cases where operation requirements such as application conditions are confirmed by our company in writing after consultation with your company.

6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
7. The products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this datasheet. Failure to employ the products in the proper applications can lead to deterioration, destruction or failure of the products. We shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of the products.
8. Quality Warranty
  - 8-1. Quality Warranty Period
 

In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
  - 8-2. Quality Warranty Remedies
 

When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.  
Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
  - 8-3. Remedies after Quality Warranty Period
 

With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
9. Anti-radiation design is not implemented in the products described in this document.
10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
13. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



**Nisshinbo Micro Devices Inc.**

**Official website**

<https://www.nisshinbo-microdevices.co.jp/en/>

**Purchase information**

<https://www.nisshinbo-microdevices.co.jp/en/buy/>